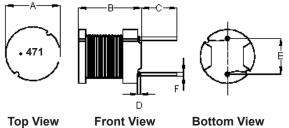
# Inductor Radial Leaded



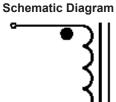
## **Configurations and Dimensions**



Note : White dot of marking indicates the start terminal of winding

## **Test Data for Mechanical**

+-	
m View	Note: 1. Wire U
start terminal of winding	2. 123.5T



1. Wire UEFN/U (155°C) Ø0.25mm

2. 123.5TS (Reference) C.W

Test Item	Α	В	С	D	E	F
lest item	mm	mm	mm	mm	mm	mm
Specification	7.8 ±0.5	9.5 ±0.5	5 ±1	3 (Max.)	5 ±0.5	Ø0.7 (Ref.)
1	7.8	9.39	5.16	1.33	4.99	0.69
2	7.81	9.43	5.18	1.28	5.17	0.71
3	7.84	9.45	5.43	1.36	4.97	0.69
4	7.8	9.44	5.2	1.45	5.1	0.7
5	7.81	9.48	5.14	1.47	5.12	0.69
Average	7.81	9.44	5.22	1.38	5.07	0.7

### **Electrical Characteristics**

Test Condition		
1kHz 0.25V	L	470µH ±20%
TA = 25°C	DCR	890Ω (Max.)
1kHz 0.25V Irms = 2.6A	ΔΤ	Temperature rise 40°C (Max.)

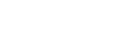
Operating temperature : -55°C to +130°C

#### **Material List**

No.	ltem	Material Description
1	Core	F4F DR2W7.8 × 9.5 (SW) RCH B4 F5.4 P5
2	Wire	Ø0.25mm UEFN/U (155°C)
3	Solder (Lead-free)	Sn99.3% / Cu0.7%

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Compliant

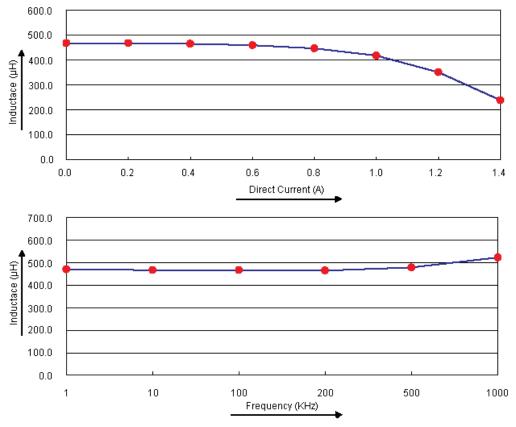
**RoHS** 

# Inductor Radial Leaded

#### **Reliability Test**

Test Item	Specifications		Test M	Test Method and Remarks		
Operating temperature range	-55°C to +130°C		Including temperature	rise due to self-generated heat.		
Storage condition	Ambient temperature Humidity	: 0°C to 40°C : Below 70% RH	To maintain the solderability of terminal electrodes, care must be taken to control temperature and humidity in the storage area.			
Moisture sensitivity	Appearance DCR change Inductance change	: No abnormality No damage : Within ±5% : Within ±5%	According to J-STD-02 Test condition Test duration Recovery	<ul> <li>0B level 3</li> <li>: 60°C 60% RH</li> <li>: 40 hrs</li> <li>: 1 to 2 hours of recovery under the standard condition after the removal from the test chamber.</li> </ul>		
Solderability	All termination shall exhibit a continuous solder coating free from defects for a minimum of 95% of the surface area of any individual lead.		According to J-STD-00 Steam aging category Steam aging duration Solder Solder temperature Dip time	: 97°C 98% RH		

### **Electric Characteristics**



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#### **Test Data for Electrical**

Test Item	L µH	DCR Ω	ΔΤ
Condition	1kHz 0.25V	at 25°C	1kHz 0.25V Irms = 0.43A
Specification	470 ±10%	890 (Max.)	Temperature rise 40°C (Max.)
1	468.76	850	
2	469.46	849.7	
3	468.58	832.4	OK
4	468.98	838.9	
5	468.3	839.8	
Average	468.82	842.16	OK

#### Part Number Table

Description	Part Number	
Inductor, 470µH, 10%, Radial Leaded	MCSCH895-471KU	

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